

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$ $I_{D}(A)$			
20	0.008 @ V _{GS} = 10 V	17		
	0.012 @ V _{GS} = 4.5 V	14		

FEATURES

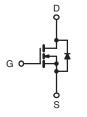
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK®
 Package with Low 1.07-mm Profile





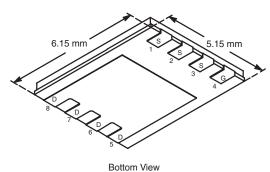
APPLICATIONS

- DC/DC conversion High-Side
 - Desktop
 - Server
- Synchronous Rectification



N-Channel MOSFET

PowerPAK SO-8



Ordering Information: Si7344DP-T1

Si7344DP-T1—E3 (Lead (Pb)-Free)

ABSOLUTE MAXIMUM RATINGS	$T_A = 25$ °C, unle	ss otherwise r	oted			
Parameter		Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V_{DS}	20		V	
Gate-Source Voltage		V_{GS}	±20			
Continuous Drain Current (T = 150°C)8	T _A = 25°C	- I _D	17	11	A	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70°C		14	9		
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	50		A	
Continuous Source Current (Diode Conduction) ^a		I _S	3.7	1.6		
Manipular Davier Dissipation	$T_A = 25^{\circ}C$	P _D	4.1	1.8	W	
Maximum Power Dissipation ^a	$T_A = 70^{\circ}C$		2.6	1.1		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}			260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	R _{thJA}	22	30		
Maximum Junction-to-Ambient	Steady State		55	70	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	4.5	5.5		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

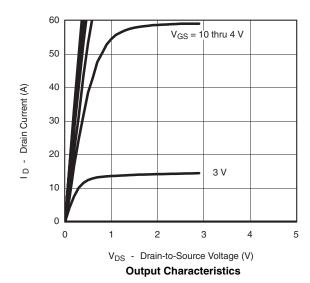
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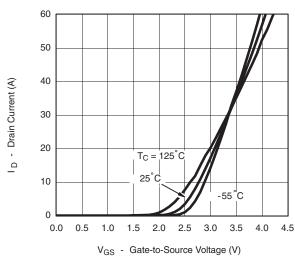


SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted							
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static						•	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.8		2.1	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA	
7 0	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	_	V _{GS} = 10 V, I _D = 17 A		0.006	0.008		
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 14 \text{ A}$		0.0095	0.012	Ω	
Forward Transconductance ^a	g _{fs}	$V_{DS} = 6 \text{ V}, I_{D} = 17 \text{ A}$		33		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 3.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	V	
Dynamic ^b	•		•	•			
Total Gate Charge	Q_g			10	15		
Gate-Source Charge	Q _{gs} Q _{gd}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 17 \text{ A}$		3.3		nC	
Gate-Drain Charge				3.1			
Gate Resistance	R_g			1.0		Ω	
Turn-On Delay Time	t _{d(on)}			14	25		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		40	65	ns	
Fall Time	t _f			15	25		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.7 A, di/dt = 100 A/μs		35	70		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted





Transfer Characteristics

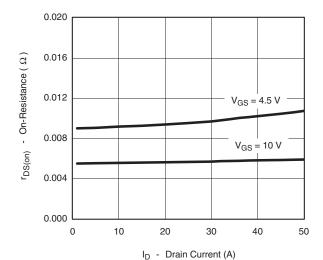
Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.



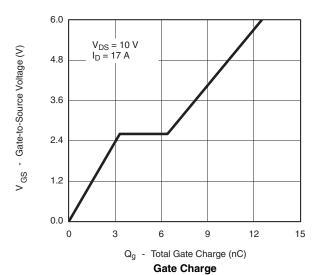


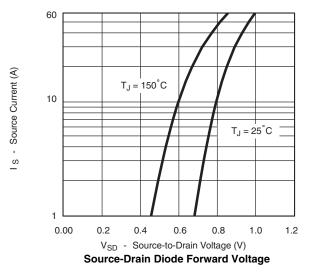


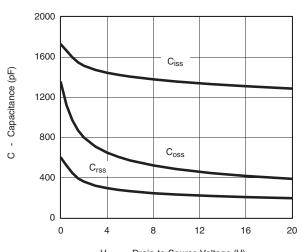
TYPICAL CHARACTERISTICS 25 °C unless noted



On-Resistance vs. Drain Current

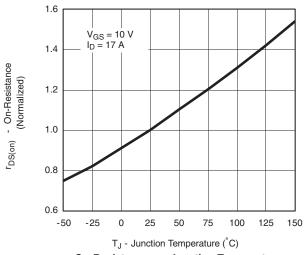




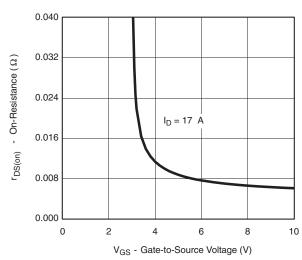


V_{DS} - Drain-to-Source Voltage (V)

Capacitance



On-Resistance vs. Junction Temperature

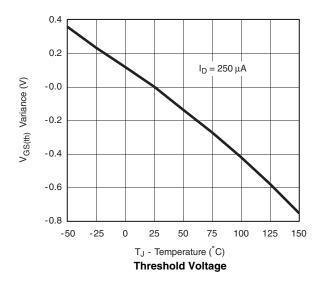


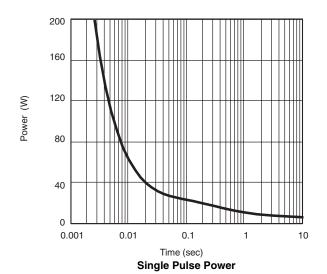
On-Resistance vs. Gate-to-Source Voltage

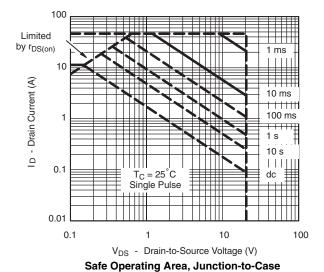
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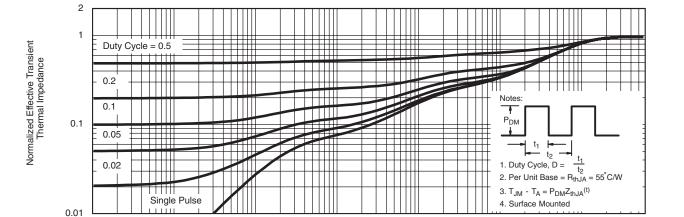
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TYPICAL CHARACTERISTICS 25 °C unless noted









Square Wave Pulse Duration (sec)

Normalized Thermal Transient Impedance, Junction-to-Ambient

10⁻¹

10-4

10-3

10-2

600

100

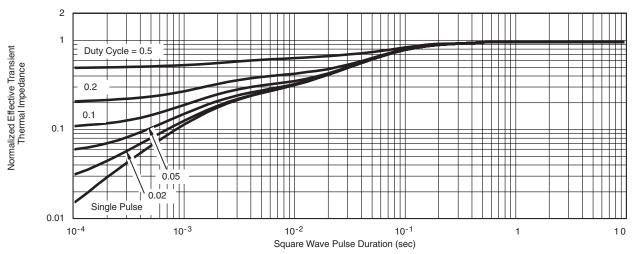
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TYPICAL CHARACTERISTICS 25 °C unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72128.

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